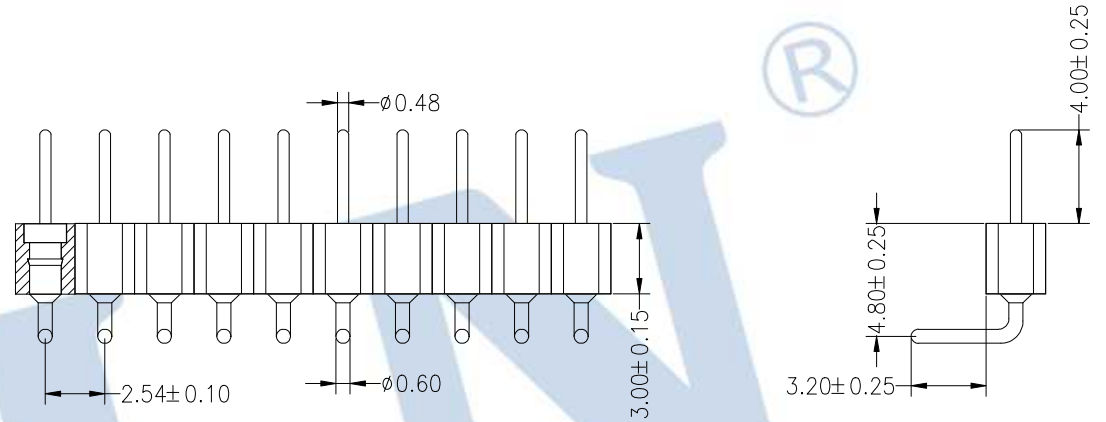
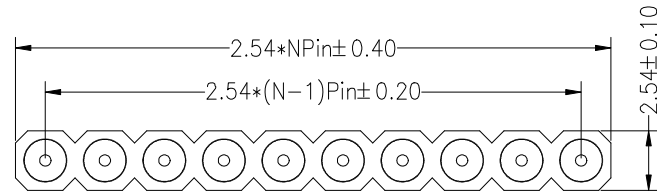


HSF RoHS

SPECIFICATIONS

Current Rating:3.0AMP
 Contact Resistance:20mΩ Max
 Dielectric Strength:Min 1000V RMS
 Operation Temperature:-40°C to +105°C

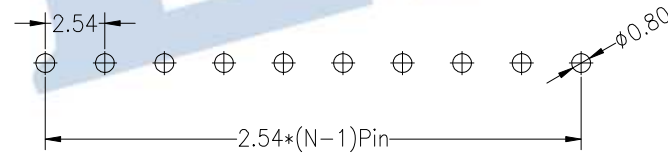
Contact Material:Copper Alloy
 Contact Plating:Au Over Ni
 Insulator Material:Polyester(UL94V-0)
 Standard: PPS
 Soldering Temperature:
 260°C±5°C For 5~10 Second



Ordering Information

3610 30 1 XX R XX 127 XX

No. of Pins Per Row NPin N=02~40
 Contact Plating
 G1:Gold Flash
 G2:1.5U" Gold
 G3:2U" Gold
 G4:3U" Gold
 G5:5U" Gold
 G6:10U" Gold
 G7:15U" Gold
 Length 127=12.76
 Stream code



Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)

				OPERATION		DRAW	Jelly Feng	2022.12.27	SCALE	FIT	JILN ® 深圳市锦凌电子有限公司 SHENZHEN JINLING ELECTRONICS CO.,LTD Tel: 86-755-2997-5806/5802 Fax: 86-755-2997-5992	
				X.X	±0.30	CHECK			UNIT	mm		
				X.XX	±0.20				SIZE	A4		
A0	2022.12.27	NEW DRAWING		X.XXX	±0.10				SHEET	1/1	TITLE:	2.54x3.0 单排90° 双头针 L=12.76 上针尖0.48 下针尖0.60
REV	DATE	MODIFICATION DESCRIPTION		CHANGE	DIM	TOL	APPROVE		PROJ.			